

75A, 1200V Hyperfast Diode

The RHRG75120 is a hyperfast diode with soft recovery characteristics ($t_{rr} < 85ns$). It has half the recovery time of ultrafast diodes and is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of high frequency switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery characteristic minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Formerly developmental type TA49042.

Ordering Information

| PART NUMBER | PACKAGE | BRAND |
|-------------|---------|-----------|
| RHRG75120 | TO-247 | RHRG75120 |

NOTE: When ordering, use the entire part number.

Symbol



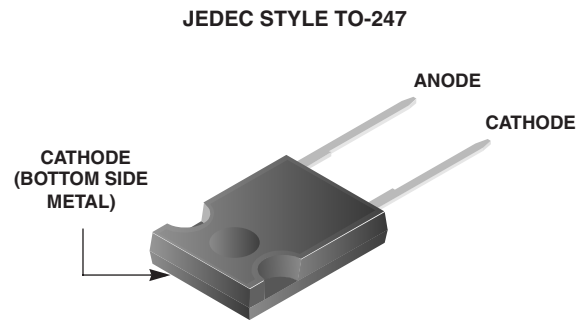
Features

- Hyperfast with Soft Recovery <85ns
- Operating Temperature 175°C
- Reverse Voltage 1200V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging



Absolute Maximum Ratings $T_C = 25^\circ C$

| | RHRG75120 | UNITS |
|---|---------------------------|-------|
| Peak Repetitive Reverse Voltage | V_{RRM} 1200 | V |
| Working Peak Reverse Voltage | V_{RWM} 1200 | V |
| DC Blocking Voltage | V_R 1200 | V |
| Average Rectified Forward Current ($T_C = 42^\circ C$) | $I_{F(AV)}$ 75 | A |
| Repetitive Peak Surge Current (Square Wave, 20kHz) | I_{FRM} 150 | A |
| Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60Hz) | I_{FSM} 500 | A |
| Maximum Power Dissipation | P_D 190 | W |
| Avalanche Energy (See Figures 7 and 8) | E_{AVL} 50 | mJ |
| Operating and Storage Temperature | T_{STG}, T_J -65 to 175 | °C |

Electrical Specifications $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

| SYMBOL | TEST CONDITION | MIN | TYP | MAX | UNITS |
|-----------------------|---|-----|-----|-----|---------------------------|
| V_F | $I_F = 75\text{A}$ | - | - | 3.2 | V |
| | $I_F = 75\text{A}, T_C = 150^\circ\text{C}$ | - | - | 2.6 | V |
| I_R | $V_R = 1200\text{V}$ | - | - | 250 | μA |
| | $V_R = 1200\text{V}, T_C = 150^\circ\text{C}$ | - | - | 2 | mA |
| t_{rr} | $I_F = 1\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | - | - | 85 | ns |
| | $I_F = 75\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | - | - | 100 | ns |
| t_a | $I_F = 75\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | - | 60 | - | ns |
| t_b | $I_F = 75\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | - | 25 | - | ns |
| $R_{\theta\text{JC}}$ | | - | - | 0.8 | $^\circ\text{C}/\text{W}$ |

DEFINITIONS

- V_F = Instantaneous forward voltage ($p_w = 300\mu\text{s}$, $D = 2\%$).
- I_R = Instantaneous reverse current.
- t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.
- t_a = Time to reach peak reverse current (See Figure 6).
- t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).
- $R_{\theta\text{JC}}$ = Thermal resistance junction to case.
- p_w = Pulse width.
- D = Duty cycle.

Typical Performance Curves

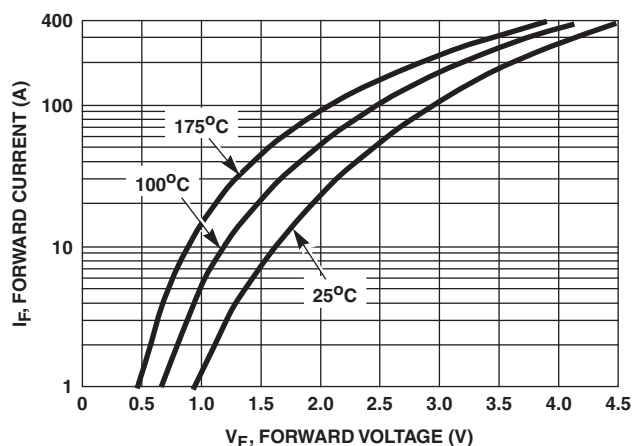


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

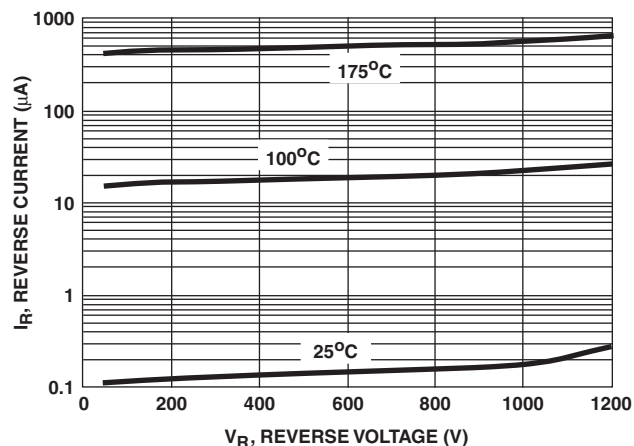


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

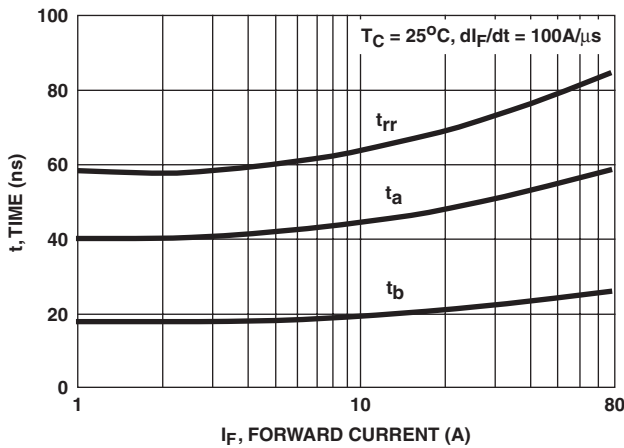


FIGURE 3. t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

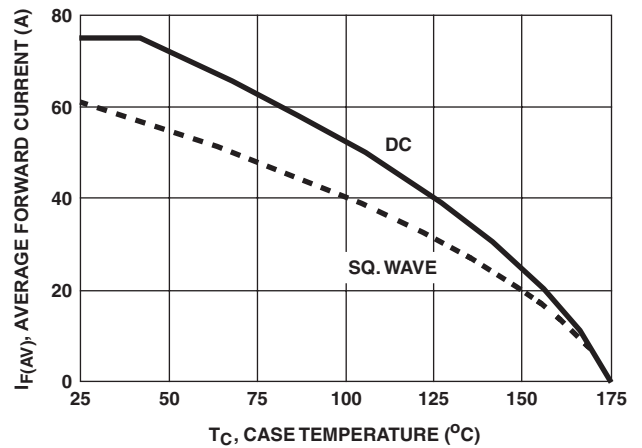


FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

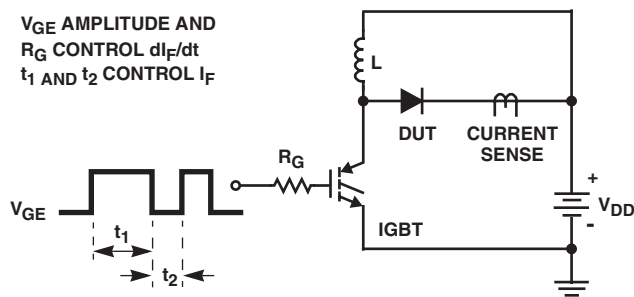


FIGURE 5. t_{rr} TEST CIRCUIT

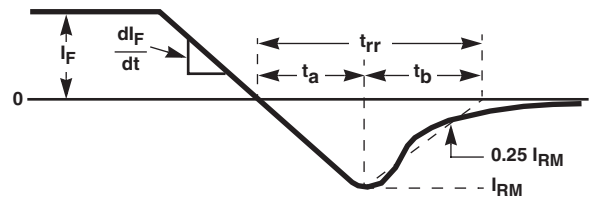


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

$I_{MAX} = 1.6A$
 $L = 40mH$
 $R < 0.1\Omega$
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
 $Q_1 = IGBT (BV_{CES} > DUT V_{R(AVL)})$

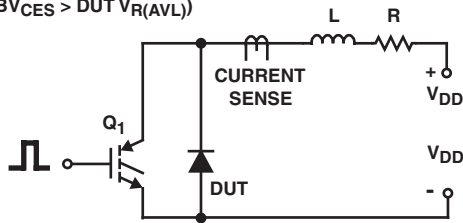


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

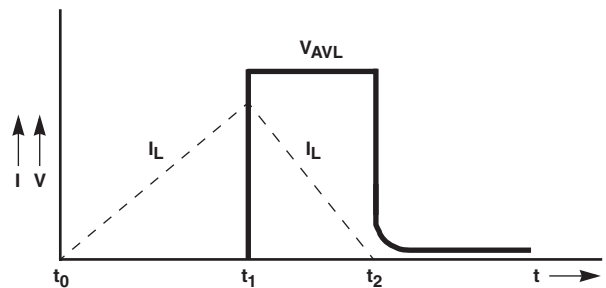





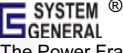


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS



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